

### **Pin Descriptions**

### Package: X1-DFN1216-4

Pin Number	Pin Name	Function
1	OUTPUT	Output Pin
2	GND	Ground Pin
3	NC	No Connection (Note 5)
4	V <sub>DD</sub>	Power Supply Input
Pad	Pad	The center exposed pad – No connection internally. The exposed pad can be left open (unconnected to ) on the PCB layout.

#### Package: X2-DFN2015-6

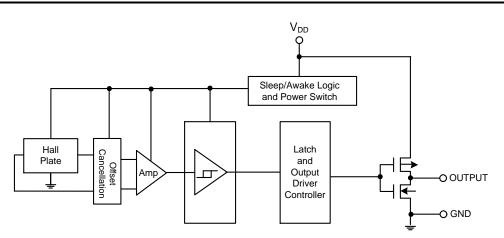
Pin Number	Pin Name	Function
1	OUTPUT	Output Pin
2	NC	No Connection (Note 5)
3	NC	No Connection (Note 5)
4	GND	Ground Pin
5	NC	No Connection (Note 5)
6	V <sub>DD</sub>	Power Supply Input
Pad	Pad	The center exposed pad – No connection internally. The exposed pad can be left open (unconnected to) on the PCB layout.

#### Package: SOT553

Pin Number	Pin Name	Function
1	NC	No Connection (Note 5)
2	GND	Ground Pin
3	NC	No Connection (Note 5)
4	V <sub>DD</sub>	Power Supply Input
5	OUTPUT	Output Pin

Note: 5. NC is "No Connection" pin and is not connected internally. This pin can be left open or tied to ground.

## **Functional Block Diagram**



AH1902



### Absolute Maximum Ratings (Note 6) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol		Parameter		
V <sub>DD</sub>	Supply Voltage (Note 7)		6	V
V <sub>DD_REV</sub>	Reverse Supply Voltage	Reverse Supply Voltage		
IOUTPUT	Output Current (source and sink)	3	mA	
В	Magnetic Flux Density	Unlimited		
D	Package Power Dissipation	X1-DFN1216-4 and X2-DFN2015-6	230	mW
PD	SOT553		230	mW
Ts	Storage Temperature Range		-65 to +150	°C
TJ	Maximum Junction Temperature	+150	°C	
ESD HBM	Human Body Model (HMB) ESD o	capability	8	kV

Notes: 6. Stresses greater than the 'Absolute Maximum Ratings' specified above may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

7. The absolute maximum V<sub>DD</sub> of 6V is a transient stress rating and is not meant as a functional operating condition. It is not recommended to operate the device at the absolute maximum rated conditions for any period of time.

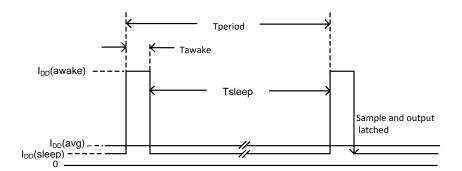
### Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Rating	Unit
V <sub>DD</sub>	Supply Voltage	Operating	1.6V to 3.6V	V
T <sub>A</sub>	Operating Temperature Range	Operating	-40 to +85	°C

### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, V<sub>DD</sub> = 1.8V, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>OL</sub>	Output Low Voltage (on)	I <sub>OUT</sub> = 1mA	—	0.1	0.2	V
Vон	Output High Voltage (off)	I <sub>OUT</sub> = -1mA	V <sub>DD</sub> -0.2	V <sub>DD</sub> -0.1	-	V
loff	Output Leakage Current	$V_{OUT} = 3.6V$ , Output off	—	< 0.1	1	μΑ
I <sub>DD</sub> (awake)	Current Current	During 'awake' period, $T_A = +25^{\circ}C, V_{DD} = 3V$	_	2.1	_	mA
I <sub>DD</sub> (sleep)	- Supply Current	During 'sleep' period, $T_A = +25^{\circ}C, V_{DD} = 3V$	_	2.5	_	μA
(aa)	Average Supply Current	$T_A = +25^{\circ}C, V_{DD} = 1.8V$	—	4.3	8	μA
I <sub>DD</sub> (avg)	Average Supply Current	$T_A = +25^{\circ}C, V_{DD} = 3.6V$	—	7.2	13	μA
Tawake	Awake Time	(Note 8)	—	50	100	μs
Tperiod	Period	(Note 8)	—	50	100	ms
D.C.	Duty Cycle	—	—	0.1	_	%

Note: 8. When power is initially turned on, the operating V<sub>DD</sub> (1.6V to 3.6V) must be applied to guaranteed the output sampling. The output state is valid after the second operating cycle (typical 100ms).



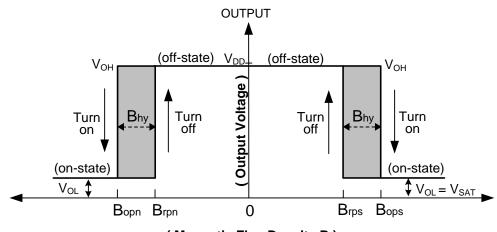


### Magnetic Characteristics (Note 9 &10) (T<sub>A</sub> = +25°C, V<sub>DD</sub> = 1.8V, unless otherwise specified)

					(1mT=10 0	Gauss)
Symbol	Characteristics	Test Condition	Min	Тур	Max	Unit
		—	23	33	47	
Bops (south pole to part marking side)		$V_{DD} = 1.6V \text{ to } 3.6V$ $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	21	33	48	
Bopn (north pole to part marking side)	Operation Point		-47	-33	-24	
		$V_{DD} = 1.6V \text{ to } 3.6V$ $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	-48	-33	-21	
		—	12	23	35	Gauss
Brps (south pole to part marking side)	Deleges Deint	$V_{DD} = 1.6V \text{ to } 3.6V$ $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	9	23	38	
	Release Point	_	-35	-23	-12	
Brpn (north pole to part marking side)		$V_{DD} = 1.6V \text{ to } 3.6V$ $T_A = -40^{\circ}\text{C to } +85^{\circ}\text{C}$	-38	-23	-9	
Bhy ( Bopx - Brpx )	Hysteresis	_	_	10	—	

Notes: 9. Typical data is at  $T_A = +25^{\circ}C$ ,  $V_{DD} = 1.8V$ .

10. Maximum and minimum parameters values over operating temperature range are not tested in production, they are guaranteed by design, characterization and process control. The magnetic characteristics may vary with supply voltage, operating temperature and after soldering.

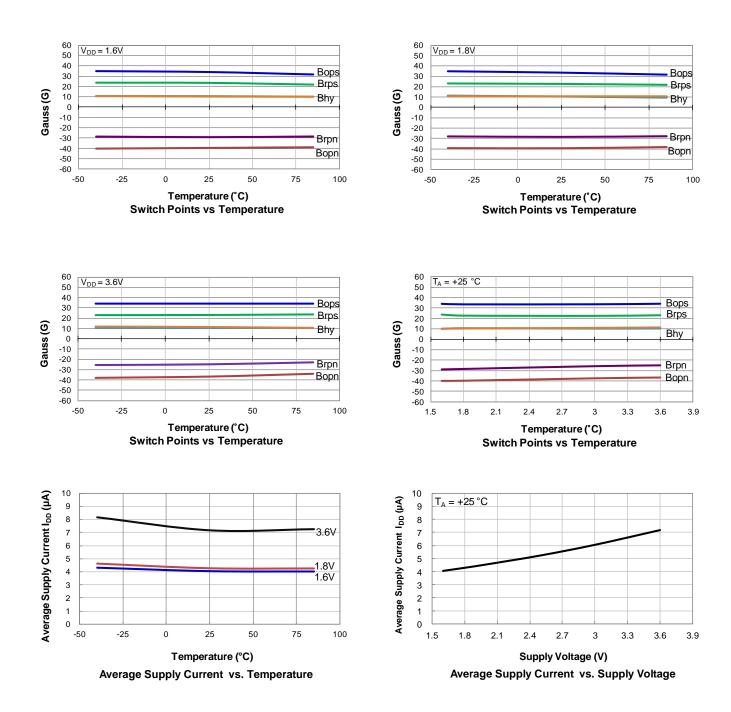


(Magnetic Flux Density B)



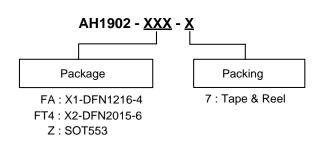
AH1902

# **Typical Operating Characteristics**





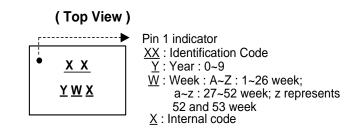
### Ordering Information



Part Number	Package	Bookoging	7" Tape a	ind Reel
Fait Nulliber	Code	Packaging	Quantity	Part Number Suffix
AH1902-FA-7	FA	X1-DFN1216-4	3,000/Tape & Reel	-7
AH1902-FT4-7	FT4	X2-DFN2015-6	3,000/Tape & Reel	-7
AH1902-Z-7	Z	SOT553	3,000/Tape & Reel	-7

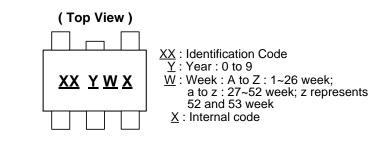
### **Marking Information**

(1) Package Type: X1-DFN1216-4 and X2-DFN2015-6



Part Number	Package	Identification Code
AH1902-FA-7	X1-DFN1216-4	F2
AH1902-FT4-7	X2-DFN2015-6	D2

#### (2) Package Type: SOT553



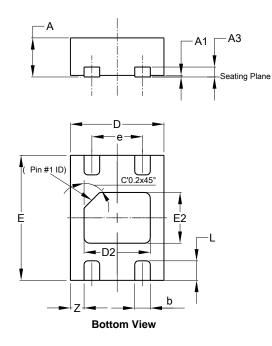
Part Number	Package	Identification Code
AH1902-Z-7	SOT553	D2



### Package Outline Dimensions (All dimensions in mm.)

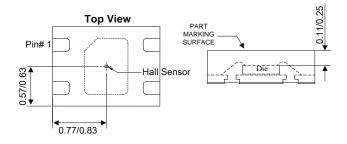
Please see http://www.diodes.com/package-outlines.html for the latest version.

### (1) Package Type: X1-DFN1216-4



	X1-DFN1216-4					
Dim	Min	Max	Тур			
Α	0.47	0.53	0.50			
A1	0.00	0.05	0.02			
A3			0.13			
b	0.15	0.25	0.20			
D	1.15	1.25	1.20			
D2	0.75	0.95	0.85			
E	1.55	1.65	1.60			
E2	0.55	0.75	0.65			
е	-	-	0.65			
L	0.20	0.30	0.25			
Z	-	-	0.175			
All C	Dimens	ions in	mm			

Min/Max



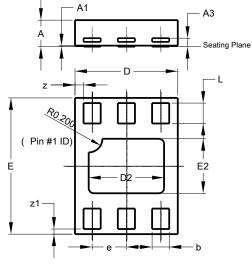
Sensor Location



### Package Outline Dimensions (continued) (All dimensions in mm.)

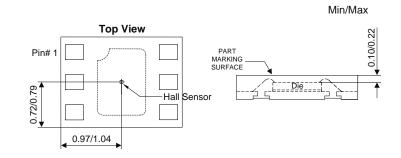
Please see http://www.diodes.com/package-outlines.html for the latest version.

#### (2) Package Type: X2-DFN2015-6



**Bottom View** 

	(2-DFI	N2015-	6
Dim	Min	Max	Тур
Α	0.375	0.40	0.390
A1	0	0.05	0.02
A3	-	-	0.13
b	0.20	0.30	0.25
D	1.45	1.575	1.50
D2	1.00	1.20	1.10
е	-	-	0.50
Е	1.95	2.075	2.00
E2	0.70	0.90	0.80
L	0.25	0.35	0.30
Z	-	-	0.125
Z1	-	-	0.075
All C	imens	ions ir	n mm



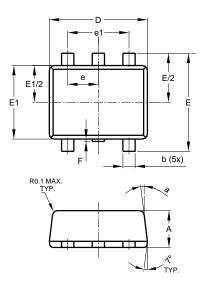
Sensor Location

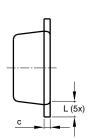


### Package Outline Dimensions (cont.) (All dimensions in mm.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

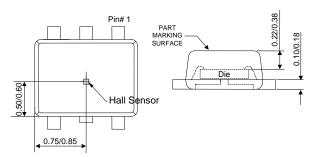
#### (3) Package Type: SOT553





SOT553				
Dim	Min	Max	Тур	
Α	0.55	0.62	0.60	
b	0.15	0.30	0.20	
С	0.10	0.18	0.15	
D	1.50	1.70	1.60	
Е	1.55	1.70	1.60	
E1	1.10	1.25	1.20	
е	0.50 BSC			
e1	1.00 BSC			
F	0.00	0.10	_	
L	0.10	0.30	0.20	
а	6°	8°	7°	
All Dimensions in mm				





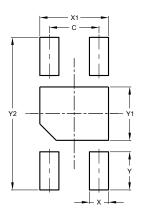
Sensor Location



## **Suggested Pad Layout**

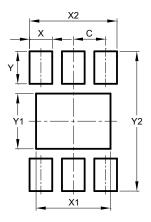
Please see http://www.diodes.com/package-outlines.html for the latest version.

### (1) Package Type: X1-DFN1216-4



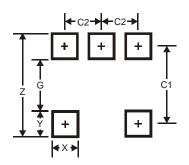
X1-DFN1216-4			
Dimensions	Value		
С	0.65		
Х	0.25		
X1	0.90		
Y	0.50		
Y1	0.70		
Y2	2.00		
All Dimensions in mm			

### (2) Package Type: X2-DFN2015-6



X2-DFN2015-6		
Dimensions	Value	
С	0.500	
Х	0.350	
X1	1.150	
X2	1.350	
Y	0.500	
Y1	0.850	
Y2	2.150	
All Dimensions in mm		

(3) Package Type: SOT553



SOT553		
Dimensions	Value	
Z	2.2	
G	1.2	
Х	0.375	
Y	0.5	
C1	1.7	
C2	0.5	
All Dimensions in mm		



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